



Drill Table

Symbol	Count	Hole Size	Plated	Drill Layer Pair	Via / Pad	Hole Tolerance		
	84	0.300mm	Plated	L01-Top Layer - L04-Bottom Layer	Via	+0.000mm/-0.300mm		
0	10	1.090mm	Plated	L01-Top Layer - L04-Bottom Layer	Pad	+/-0.076mm		
✡	9	1.200mm	Plated	L01-Top Layer - L04-Bottom Layer	Pad	+/-0.075mm		
∇	2	3.000mm	Non-Plated	L01-Top Layer - L04-Bottom Layer	Pad	+/-0.051mm		
Ħ	4	3.700mm	Plated	L01-Top Layer - L04-Bottom Layer	Pad	+/-0.075mm		
	109 Total							

REV	DESCRIPTION	DATE	APPROVED
X1	INITIAL RELEASE	01/24/2023	

NOTES: UNITS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED

- 1. INTERPRET THIS DRAWING IN ACCORDANCE WITH IPC-D-325A.
- 2. BOARD FABRICATION AND QUALITY PER IPC-6012, CLASS 2, EXCEPT SPECIFIED HEREIN.
- 3. MUST COMPLY WITH EUROPEAN DIRECTIVE 2002/95/EC (RoHS).
- 4. DIMENSIONAL LIMITS APPLY AFTER PLATING OR COATING.
- 5. BOW AND TWIST MAXIMUM IS 0.75%.
- 6. MATERIAL: LAMINATE AND PREPREG SHALL BE IN ACCORDANCE WITH IPC-4101/21. 170 DEGREES CELSIUS MINIMUM Tg, UL 94V-0.
- 7. STACKUP SUMMARY:
 - A. NUMBER OF COPPER LAYERS: 4
 - B. BOARD THICKNESS SHALL BE 1.6mm +/- 10%
 - C. COPPER: See Laver Stack
 - D. DEFAULT TRACE/SPACE: 0.2mm/0.2mm
 - E. CONDUCTOR WIDTH TOLERANCE = +/- 0.01mm
- 8. ALL VIAS TO BE TENTED BY SOLDERMASK
- 9. SURFACE FINISH/PLATING:
 - A. BOARD SHALL BE IMMERSION GOLD PLATED (ENIG) ACCORDING TO IPC-4552. THICKNESS SHALL BE A MINIMUM OF 0.05µm GOLD OVER 3-6µm NICKEL.
- 10. SOLDERMASK WITH LIQUID PHOTO IMAGEABLE (LPI) PER IPC-SM-840C, CLASS T. COLOR: BLACK
- 11. SILKSCREEN PER SUPPLIED ARTWORK WITH ORGANIC, NON-CONDUCTIVE, EPOXY INK. SILKSCREEN MAY BE TRIMMED OFF ANY SOLDERABLE ENTITY. COLOR: WHITE
- 12. 100% BARE BOARD ELECTRICAL TEST TO BE DONE WITH REFERENCE TO SUPPLIED NETLIST.
- 13. LOCATE MANUFACTURER'S IDENTIFICATION AND LOT CODE ON PRIMARY SIDE FREE FROM ALL METAL ENTITY RENDERED IN SILKSCREEN.
- 14. CONTROLLED IMPEDANCE REQUIRED ON BOARD. SEE TABLE 1: SINGLE ENDED CONTROLLED IMPEDANCE

TABLE1: SINGLE ENDED CONTROLLED IMPEDANCE

Trace layer	Reference layers	Target Impedance	Wide Trace Width	Target Tolerance
L01-Top Layer	L02-Inner Layer	50	0.19mm	10%
L04-Bottom Layer	L03-Inner Layer	50	0.19mm	10%